

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	0	(dummy unus\$4 (non adj eject\$3)) adj2 nozzle same (scant\$3 slant\$4 diagonal\$3 angle\$3) near3 (arrang\$4 position\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT
2	BRS	L2	775	(dummy unus\$4 (non adj eject\$3)) adj2 nozzle end near4 (array row column) adj2 nozzle	US-PGPUB; USPAT; EPO; JPO; DERWENT
3	BRS	L3	0	(dummy unus\$4 (non adj eject\$3)) adj2 nozzle same end near4 (array row column) adj2 nozzle	US-PGPUB; USPAT; EPO; JPO; DERWENT
4	BRS	L4	767	(color adj2 filter) near2 (material liquid substance) and (electroluminescent EL) and (crystal adj display)	US-PGPUB; USPAT; EPO; JPO; DERWENT
5	BRS	L5	5150	nozzle same (scant\$3 slant\$4 diagonal\$3 angle\$3) near3 (arrang\$4 position\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT
6	BRS	L8	0	6 and 7	US-PGPUB; USPAT; EPO; JPO; DERWENT
7	BRS	L6	4	4 and 5	US-PGPUB; USPAT; EPO; JPO; DERWENT
8	BRS	L7	5	ink adj4 supply\$3 adj3 (port inlet pipe conduit) same thermal\$3 adj2 (expansion expand\$4 coefficient factor) with (higher differen\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT
9	BRS	L9	14863 23	ink adj4 supply\$3 adj3 (port inlet pipe conduit) same thermal\$3 adj2 (expansion stress) with high\$2 (coefficient factor)	US-PGPUB; USPAT; EPO; JPO; DERWENT
10	BRS	L10	7	ink adj4 supply\$3 adj3 (port inlet pipe conduit) same thermal\$3 adj2 (expansion stress) with high\$2 near3 (coefficient factor)	US-PGPUB; USPAT; EPO; JPO; DERWENT
11	BRS	L11	3158	347/40,71,85.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT
12	BRS	L12	653	11 and (7 9 10)	US-PGPUB; USPAT; EPO; JPO; DERWENT
13	BRS	L13	3	11 and (7 10)	US-PGPUB; USPAT; EPO; JPO; DERWENT
14	BRS	L14	47	29/890.1 and 12	US-PGPUB; USPAT; EPO; JPO; DERWENT

	Type	Hits	Search Text	DBs
93	BRS	0	dummy adj2 (chip print\$4 head) same "not" adj eject\$4	US-PGPUB; USPAT; USOCR
94	BRS	8	ink near2 (groove path channel\$4) adj3 (plate substrate) same heat\$4 near3 (sink dissipat\$4)	US-PGPUB; USPAT; USOCR
95	BRS	5	dummy adj2 (chip print\$4 head) same alternat\$4 adj3 (dispos\$4 plac\$4 arrang\$4)	US-PGPUB; USPAT; USOCR
96	BRS	16	347/42.ccls. and dummy	US-PGPUB; USPAT; USOCR
97	BRS	1459	("4463359").URPN.	USPAT
98	BRS	5	dummy adj2 (chip print\$4 head subunit die) same alternat\$4 adj3 (dispos\$4 plac\$4 arrang\$4)	US-PGPUB; USPAT; USOCR
99	BRS	5	ink near2 (groove path channel\$4) with (plate substrate) same heat\$4 near3 (sink dissipat\$4) with (adhesive bond\$4 seal\$3)	US-PGPUB; USPAT; USOCR
100	BRS	2	dummy adj2 (chip print\$4 head subunit die) and (nguyen adj thinh)	US-PGPUB; USPAT; USOCR

	Time Stamp	Comments	Error Definition	Errors	Ref #
93	2004/11/15 08:20				S94
94	2004/11/15 08:36				S93
95	2004/11/15 09:24				S95
96	2004/11/15 08:24				S96
97	2004/11/15 08:32				S97
98	2004/11/15 08:48				S98
99	2004/11/15 08:38				S99
100	2004/11/15 08:49				S100